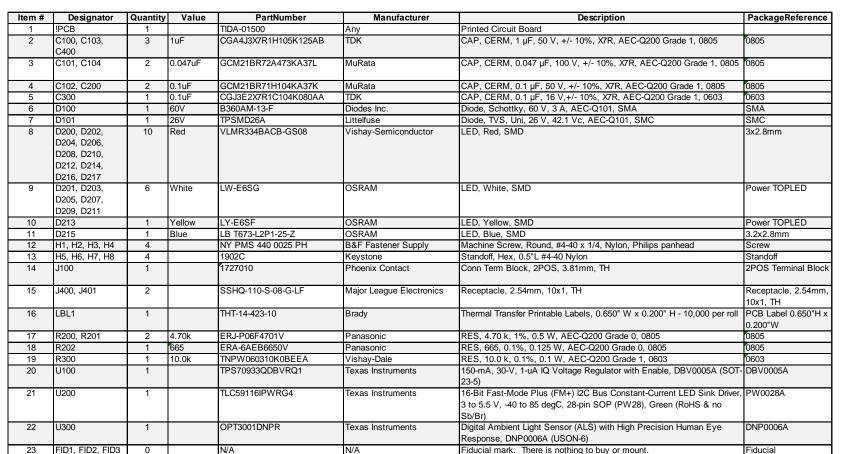
Filename:
 ProADFE.tmp

 Variant:
 001

 Generated:
 10/25/2017 1:33:59 PM

 TID #:
 N/A

TIDA-01500 REV E1 Bill of Materials





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